

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

DALSON YE SENG KIM
JEFFREY TOH TUCK FOOK
LEE CHOON KUAN

Serial No.:

Filing Date: Concurrently Herewith

Title: SEMICONDUCTOR COMPONENT HAVING CHIP ON BOARD
LEADFRAME AND METHOD OF FABRICATION

Docket No. 02-1467

ELECTION UNDER 37 C.F.R. §§3.71 AND 3.73 AND POWER OF ATTORNEY

Assistant Commissioner for Patents
Washington, DC 20231

Dear Sir:

The undersigned, being Assignee of the entire interest in the above-identified application by virtue of an Assignment recorded in the United States Patent and Trademark Office as set forth below or filed herewith, hereby elects, under 37 C.F.R. §3.71, to prosecute the application to the exclusion of the inventor(s).

The Assignee hereby revokes any previous Powers of Attorney and appoints: Stephen A. Gratton, Reg. No. 28,418; Michael L. Lynch, Reg. No. 30,871; Charles B. Brantley, II, Reg. No. 38,086; Kevin D. Martin, Reg. No. 37,882; and David J. Paul, Reg. No. 34,692, as its attorney or agent, with full power of substitution and revocation, to prosecute the application; to make alterations and amendments therein, to transact all business in the Patent and Trademark Office in connection therewith, to receive any Letters Patent, and for one year after issuance of such Letters Patent to file any request for a certificate of correction that may be deemed appropriate.

Pursuant to 37 C.F.R. §3.73, the undersigned duly authorized designee of Assignee certifies that the evidentiary documents have been reviewed, specifically the Assignment to MICRON TECHNOLOGY, INC., referenced below, and certifies that to the best of my knowledge and belief, title remains in the name of the Assignee.

Assignment:

 x Filed concurrently herewith for
recording, a copy of which is
attached hereto.

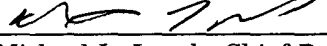
_____ Previously recorded on _____
at Reel/Frame _____

Please direct all communication as follows:

Stephen A. Gratton
THE LAW OFFICE OF STEPHEN A. GRATTON
2764 South Braun Way
Lakewood, CO 80228
(303) 989 6353

ASSIGNEE: MICRON TECHNOLOGY, INC.

Date: 7-17-03

By: 
Michael L. Lynch, Chief Patent Counsel

**DECLARATION AND POWER OF ATTORNEY
FOR PATENT APPLICATION
(Joint Inventors)**

We as the below named inventors, declare that:

Our residences, post office addresses and citizenships are as stated below next to our names.

We believe we are the original, first and joint inventors of the subject matter which is claimed and for which patent is sought on the invention entitled:

**SEMICONDUCTOR COMPONENT HAVING CHIP
ON BOARD LEADFRAME AND METHOD OF FABRICATION**

the specification of which (check one)

☒ is attached hereto.

☐ was filed Application Serial No. _____
and was amended on (if applicable) _____.

We hereby state that we have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

We acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, Sec. 1.56(a).

We hereby claim foreign priority under Title 35, United States Code, Sec. 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed: NONE

We hereby claim the benefit under Title 35, United States Code, Sec. 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, Sec. 11, we acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, Sec. 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application: NONE


POWER OF ATTORNEY: We hereby appoint as our attorneys, Stephen A. Gratton, Reg. No. 28,418; Michael L. Lynch, Reg. No. 30,871; Charles B. Brantley, II, Reg. No. 38,086; Kevin D. Martin, Reg. No. 37,882; and David J. Paul, Reg. No. 34,692, with full power of substitution and revocation, to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith. All correspondence and telephonic communications should be directed to:

STEPHEN A. GRATTON
2764 South Braun Way
Lakewood, CO 80228

Telephone: (303) 989 6353
Fax: (303) 989 6538

We hereby declare that all statements made herein of our own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and such willful false statements may jeopardize the validity of the application or any patent issued thereon.


Wherefore, we pray that Letters Patent be granted to us for the invention or discovery described and claimed in the foregoing specification and claims, declaration, power of attorney, and this petition.

INVENTOR'S FULL NAME:	DALSON YE SENG KIM
INVENTOR'S SIGNATURE:	 _____
DATE OF SIGNATURE:	<u>7 JUL 2003</u>
RESIDENCE (CITY AND STATE)	Republic of Singapore
CITIZENSHIP:	Republic of Singapore
POST OFFICE ADDRESS:	No. 13, Valley Road Singapore 534466

INVENTOR'S FULL NAME:

JEFFREY TOH TUCK FOOK

INVENTOR'S SIGNATURE:



DATE OF SIGNATURE:

_____ **7 JUL 2003** _____

RESIDENCE (CITY AND STATE)

Singapore

CITIZENSHIP:

Singapore

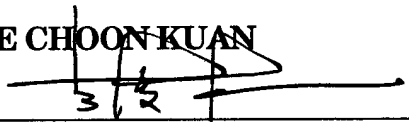
POST OFFICE ADDRESS:

Blk 447 #13-117, Bright Hill Drive
Singapore 570447

INVENTOR'S FULL NAME:

LEE CHOON KUAN

INVENTOR'S SIGNATURE:



DATE OF SIGNATURE:

_____ **7 JUL 2003** _____

RESIDENCE (CITY AND STATE)

Republic of Singapore

CITIZENSHIP:

Republic of Singapore

POST OFFICE ADDRESS:

Block 46 #07-651,
Circuit Road
Apt #07-651
Singapore 370046